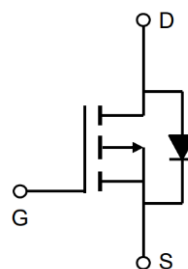


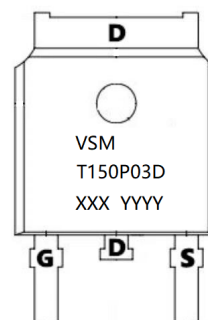
## General Features

| $V_{DS}$ | $I_D$ | $R_{DS(ON)}$ Type<br>@ $V_{GS} = -10V$ | $R_{DS(ON)}$ Type<br>@ $V_{GS} = -4.5V$ |
|----------|-------|----------------------------------------|-----------------------------------------|
| -30V     | -30A  | 15 m $\Omega$                          | 23 m $\Omega$                           |



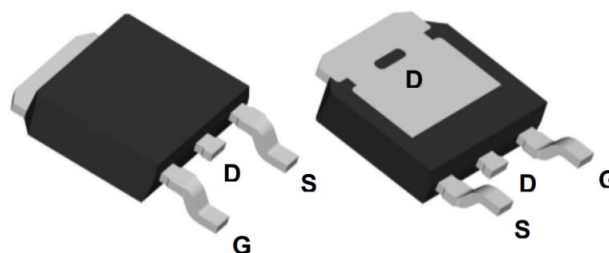
## Description

The VSMT150P03DA1 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



## Application

Lithium battery protection  
Wireless impact  
Mobile phone fast charging



## Package Marking and Ordering Information

| Product ID    | Pack      | Marking               | Qty(PCS) |
|---------------|-----------|-----------------------|----------|
| VSMT150P03DA1 | TO-252-3L | VSM T150P03D XXX YYYY | 2500     |

## Absolute Maximum Ratings (TC=25°C unless otherwise noted)

| Symbol                 | Parameter                                              | Rating     | Units |
|------------------------|--------------------------------------------------------|------------|-------|
| $V_{DS}$               | Drain-Source Voltage                                   | -30        | V     |
| $V_{GS}$               | Gate-Source Voltage                                    | $\pm 20$   | V     |
| $I_{D@TC=25^\circ C}$  | Continuous Drain Current, $V_{GS} @ -10V$ <sup>1</sup> | -30        | A     |
| $I_{D@TC=100^\circ C}$ | Continuous Drain Current, $V_{GS} @ -10V$ <sup>1</sup> | -20        | A     |
| $I_{DM}$               | Pulsed Drain Current <sup>2</sup>                      | -68        | A     |
| EAS                    | Single Pulse Avalanche Energy <sup>3</sup>             | 125        | mJ    |
| $PD@TC=25^\circ C$     | Total Power Dissipation <sup>4</sup>                   | 29         | W     |
| TSTG                   | Storage Temperature Range                              | -55 to 150 | °C    |
| TJ                     | Operating Junction Temperature Range                   | -55 to 150 | °C    |
| $R_{\theta JA}$        | Thermal Resistance Junction-Ambient <sup>1</sup>       | 62.5       | °C/W  |
| $R_{\theta JC}$        | Thermal Resistance Junction-Case <sup>1</sup>          | 3.6        | °C/W  |

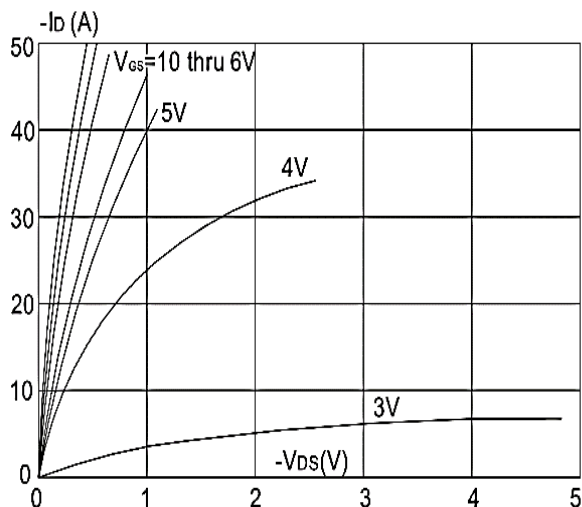
**Electrical Characteristics ( $T_J=25^{\circ}\text{C}$ , unless otherwise noted)**

| Symbol   | Parameter                                                | Test Condition                                         | Min. | Typ. | Max.      | Units      |
|----------|----------------------------------------------------------|--------------------------------------------------------|------|------|-----------|------------|
| V(BR)DSS | Drain-Source Breakdown Voltage                           | $V_{GS}=0V, I_D=-250\mu A$                             | -30  | -33  | -         | V          |
| IDSS     | Zero Gate Voltage Drain Current                          | $V_{DS}=-30V, V_{GS}=0V$                               | -    | -    | -1        | $\mu A$    |
| IGSS     | Gate to Body Leakage Current                             | $V_{DS}=0V, V_{GS}=\pm 20V$                            | -    | -    | $\pm 100$ | nA         |
| VGS(th)  | Gate Threshold Voltage                                   | $V_{DS}=V_{GS}, I_D=-250\mu A$                         | -1.2 | -1.5 | -2.5      | V          |
| RDS(on)  | Static Drain-Source on-Resistance note3                  | $V_{GS}=-10V, I_D=-10A$                                | -    | 15   | 20        | m $\Omega$ |
|          |                                                          | $V_{GS}=-4.5V, I_D=-5A$                                | -    | 23   | 30        |            |
| Ciss     | Input Capacitance                                        | $V_{DS}=-15V, V_{GS}=0V, f=1.0MHz$                     | -    | 1250 | -         | pF         |
| Coss     | Output Capacitance                                       |                                                        | -    | 327  | -         | pF         |
| Crss     | Reverse Transfer Capacitance                             |                                                        | -    | 278  | -         | pF         |
| Qg       | Total Gate Charge                                        | $V_{DS}=-15V, I_D=-9.1A, V_{GS}=-10V$                  | -    | 30   | -         | nC         |
| Qgs      | Gate-Source Charge                                       |                                                        | -    | 5.3  | -         | nC         |
| Qgd      | Gate-Drain("Miller") Charge                              |                                                        | -    | 7.6  | -         | nC         |
| td(on)   | Turn-on Delay Time                                       | $V_{DD}=-15V, I_D=-6A, V_{GS}=-10V, R_{GEN}=2.5\Omega$ | -    | 14   | -         | ns         |
| tr       | Turn-on Rise Time                                        |                                                        | -    | 20   | -         | ns         |
| td(off)  | Turn-off Delay Time                                      |                                                        | -    | 95   | -         | ns         |
| tf       | Turn-off Fall Time                                       |                                                        | -    | 65   | -         | ns         |
| IS       | Maximum Continuous Drain to Source Diode Forward Current |                                                        | -    | -    | -10       | A          |
| ISM      | Maximum Pulsed Drain to Source Diode Forward Current     |                                                        | -    | -    | -40       | A          |
| VSD      | Drain to Source Diode Forward Voltage                    | $V_{GS}=0V, I_S=-11A$                                  | -    | -0.8 | -1.2      | V          |

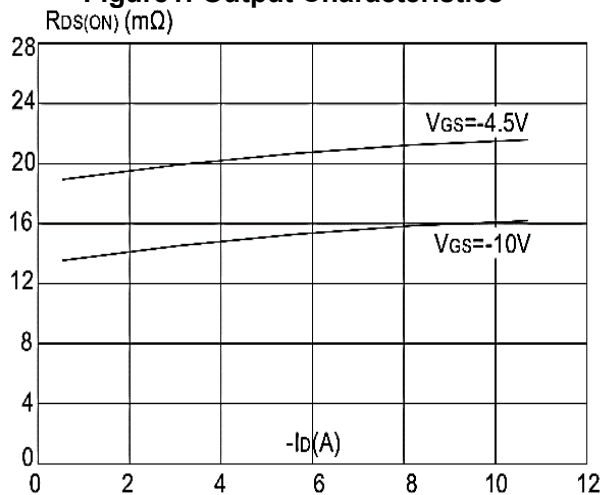
**Note :**

- 1、The data tested by surface mounted on a 1 inch 2 FR-4 board with 20Z copper.
- 2、The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$
- 3、The power dissipation is limited by  $150^{\circ}\text{C}$  junction temperature
- 4、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

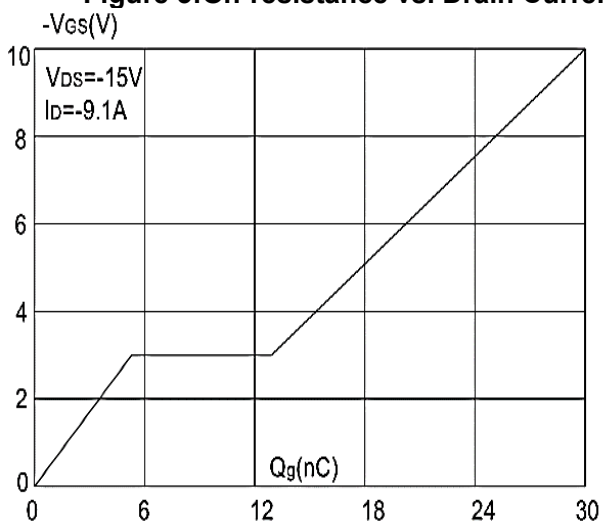
## Typical Characteristics



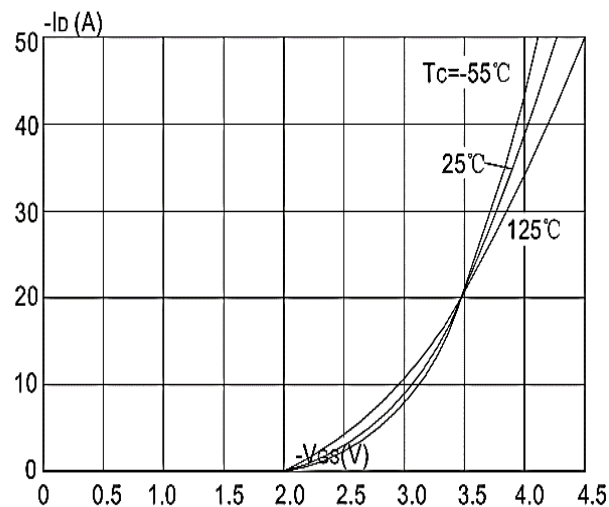
**Figure 1: Output Characteristics**



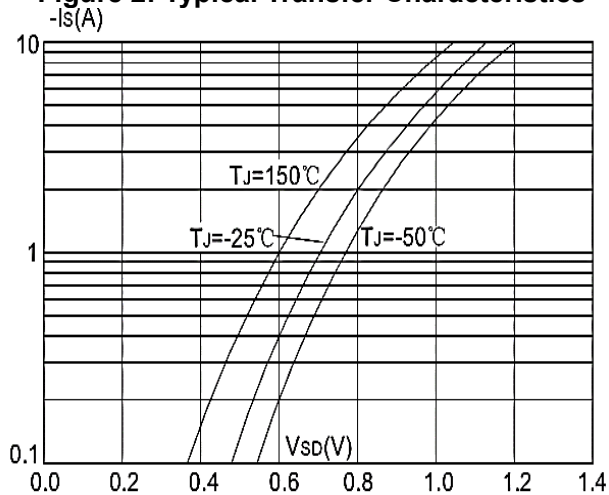
**Figure 3: On-resistance vs. Drain Current**



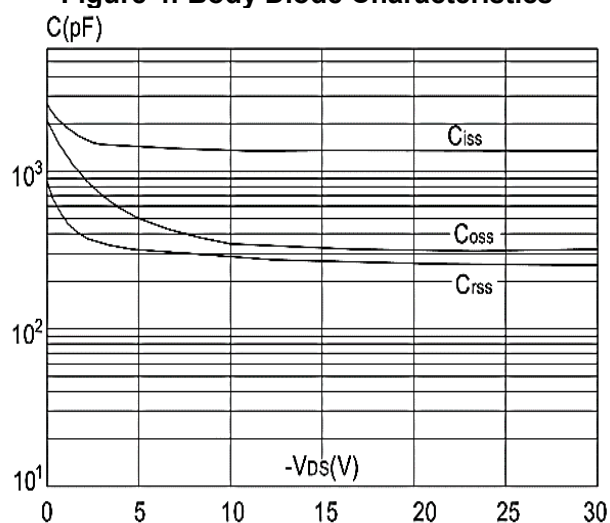
**Figure 5: Gate Charge Characteristics**



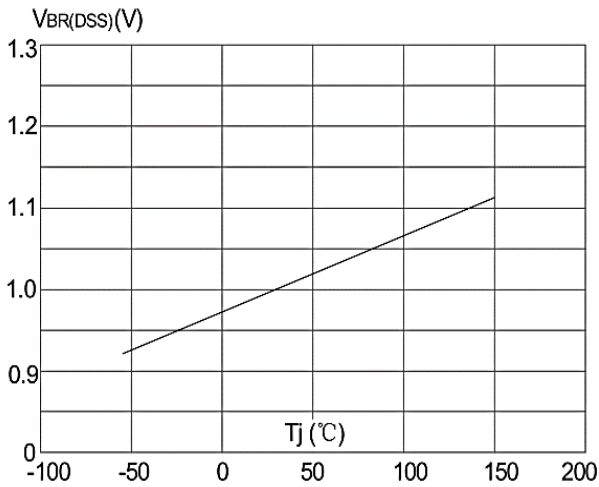
**Figure 2: Typical Transfer Characteristics**



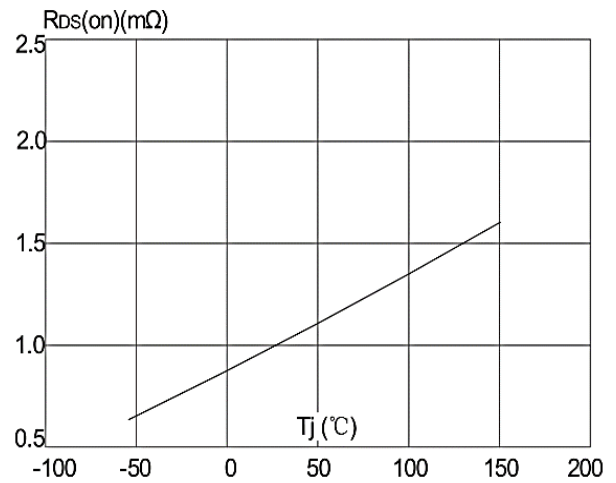
**Figure 4: Body Diode Characteristics**



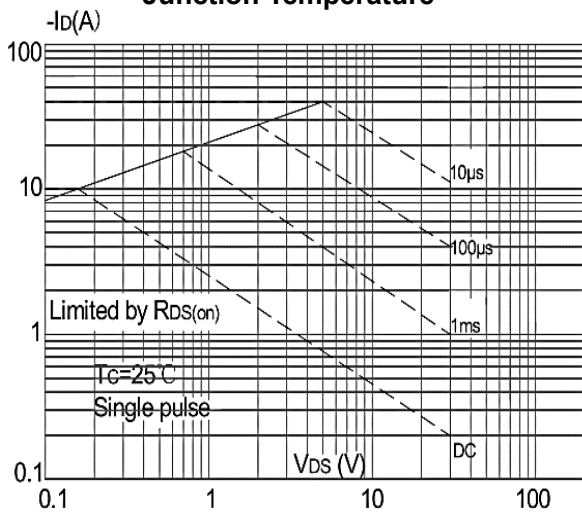
**Figure 6: Capacitance Characteristics**



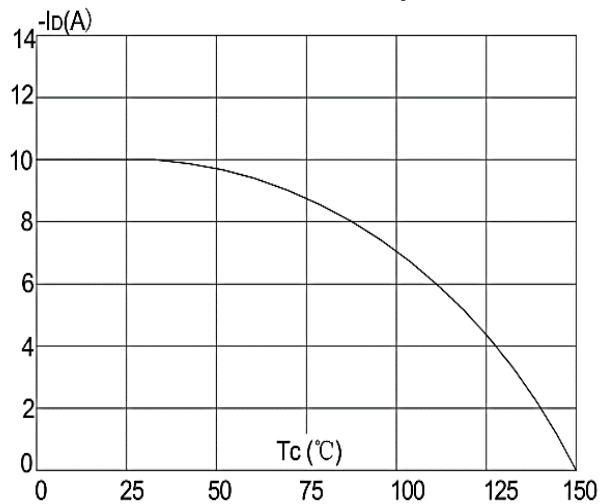
**Figure 7: Normalized Breakdown Voltage vs. Junction Temperature**



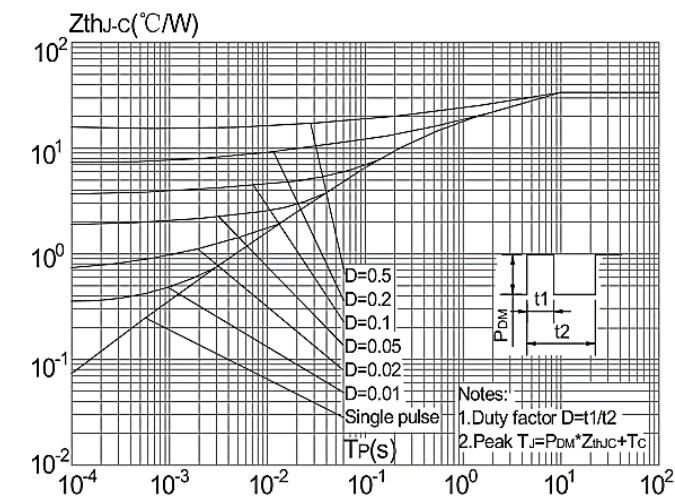
**Figure 8: Normalized on Resistance vs. Junction Temperature**



**Figure 9: Maximum Safe Operating Area**

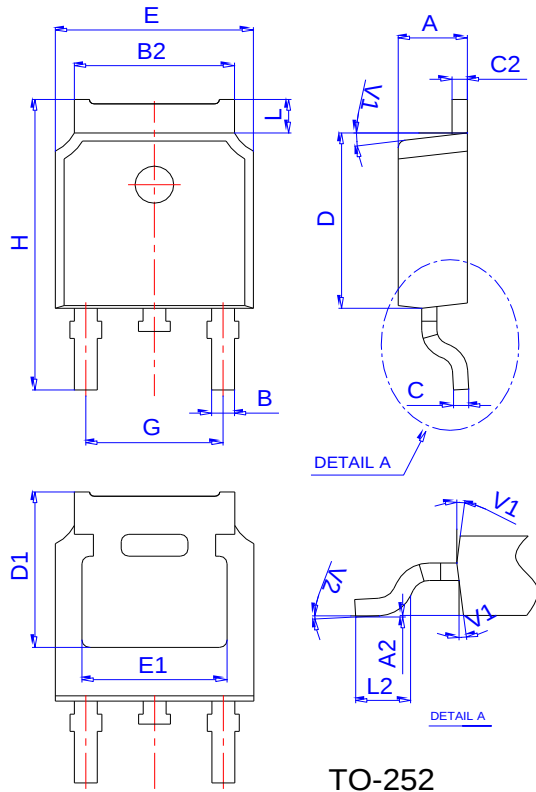


**Figure 10: Maximum Continuous Drain Current vs. Ambient Temperature**



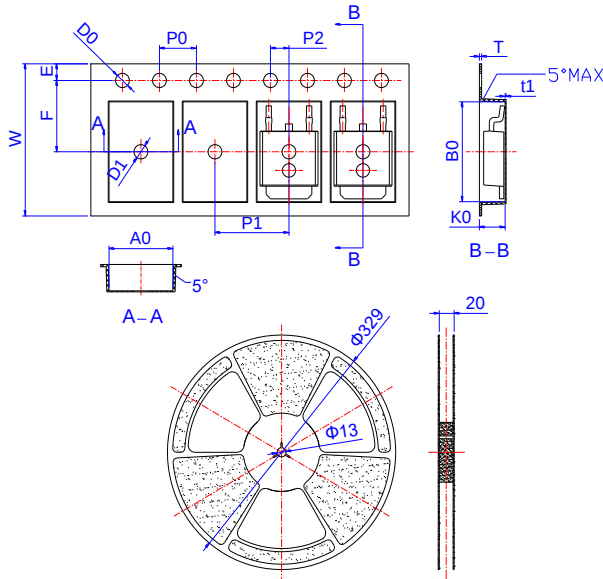
**Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Ambient**

### Package Mechanical Data:TO-252-3L



| Ref. | Dimensions  |      |       |          |      |       |
|------|-------------|------|-------|----------|------|-------|
|      | Millimeters |      |       | Inches   |      |       |
|      | Min.        | Typ. | Max.  | Min.     | Typ. | Max.  |
| A    | 2.10        |      | 2.50  | 0.083    |      | 0.098 |
| A2   | 0           |      | 0.10  | 0        |      | 0.004 |
| B    | 0.66        |      | 0.86  | 0.026    |      | 0.034 |
| B2   | 5.18        |      | 5.48  | 0.202    |      | 0.216 |
| C    | 0.40        |      | 0.60  | 0.016    |      | 0.024 |
| C2   | 0.44        |      | 0.58  | 0.017    |      | 0.023 |
| D    | 5.90        |      | 6.30  | 0.232    |      | 0.248 |
| D1   | 5.30REF     |      |       | 0.209REF |      |       |
| E    | 6.40        |      | 6.80  | 0.252    |      | 0.268 |
| E1   | 4.63        |      |       | 0.182    |      |       |
| G    | 4.47        |      | 4.67  | 0.176    |      | 0.184 |
| H    | 9.50        |      | 10.70 | 0.374    |      | 0.421 |
| L    | 1.09        |      | 1.21  | 0.043    |      | 0.048 |
| L2   | 1.35        |      | 1.65  | 0.053    |      | 0.065 |
| V1   |             | 7°   |       |          | 7°   |       |
| V2   | 0°          |      | 6°    | 0°       |      | 6°    |

### Reel Spectification-TO-252



| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| W    | 15.90       | 16.00 | 16.10 | 0.626  | 0.630 | 0.634 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| D0   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| D1   | 1.40        | 1.50  | 1.60  | 0.055  | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 7.90        | 8.00  | 8.10  | 0.311  | 0.315 | 0.319 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| A0   | 6.85        | 6.90  | 7.00  | 0.270  | 0.271 | 0.276 |
| B0   | 10.45       | 10.50 | 10.60 | 0.411  | 0.413 | 0.417 |
| K0   | 2.68        | 2.78  | 2.88  | 0.105  | 0.109 | 0.113 |
| T    | 0.24        |       | 0.27  | 0.009  |       | 0.011 |
| t1   | 0.10        |       |       | 0.004  |       |       |
| 10P0 | 39.80       | 40.00 | 40.20 | 1.567  | 1.575 | 1.583 |